

भारत सरकार
Government of India
इलेक्ट्रॉनिकी और सूचना प्रौद्योगिकी मंत्रालय
Ministry of Electronics & Information Technology
इलेक्ट्रॉनिक्स निकेतन, 6, सी जी ओ कॉम्प्लेक्स, नई दिल्ली-110003
Electronics Niketan, 6, C G O Complex, New Delhi-110003
Website: www.meity.gov.in

संख्या
No.....36(9)/2017-IPHW (Vol. II)

दिनांक
Date.....7th December, 2017

Shri Narsimhan L.V

Vice President

M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited

Electronic Manufacturing Cluster (EMC)-1, Near Tirupati Airport

Renigunta Mandal, Chittoor District

Andhra Pradesh-517520

Subject: Electronics Manufacturing Clusters (EMC) Scheme- Final approval for Greenfield Electronics Manufacturing Cluster at Renigunta and Yerpedu Mandal, Chittoor District, Near Airport, Tirupati, Andhra Pradesh

References:

- Final application submitted vide letter no. CELKON/CMD/DeitY/N.O/004 dated 29th January, 2017 and documents/correspondences made thereafter by M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited
- EMC Policy Gazette Notification no. 252 dated 22nd October 2012 [F.No.8 (50)/2011 – IPHW]
- Guidelines for operationlization of EMC Scheme dated 15th April 2013 [F.No.8 (50)/2011– IPHW]
- Guidelines for constitution of SPV dated 30th January 2014 [F.No.8 (131)/2012 – IPHW]

Sir,

Reference is invited to final application submitted vide letter no. CELKON/CMD/DeitY/N.O/004 dated 29th January, 2017 cited under reference 1 above and correspondences made thereafter for seeking grant assistance under Electronics Manufacturing Cluster (EMC) Scheme from this Ministry for setting up of Greenfield Electronics Manufacturing Cluster at Renigunta and Yerpedu Mandal, Chittoor District, Near Airport, Tirupati, Andhra Pradesh. The said application and documents submitted by you have been considered by the Ministry of Electronics and Information Technology (MeitY) and on the basis of the assurances and commitments made therein, I am directed to convey the approval of the competent authority for setting up of Greenfield Electronics Manufacturing Cluster over an area of 113.27 acres at Renigunta and Yerpedu Mandal, Chittoor District, Near Airport, Tirupati, Andhra Pradesh with a project cost of Rs. 104,40,66,458/- (Rs. One Hundred Four Crore Forty Lakh Sixty Six Thousand Four Hundred Fifty Eight only) [excluding land cost] providing Grant-in-aid of Rs. 46,52,96,066/- (Rs. Forty Six Crore Fifty Two Lakh Ninety Six Thousand Sixty Six only).

2. The parameters of the project are mentioned hereunder. The area mentioned below is being notified as a Greenfield Electronic Manufacturing Cluster under the EMC Scheme of MeitY.

#	Project Parameter(s)	Details												
1.	Name of the Applicant	M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited- (Special Purpose Vehicle)												
2.	Location details of the Greenfield EMC	<p>Renigunta and Yerpedu Mandal , Chittoor District, Near Airport, Tirupati, Andhra Pradesh</p> <table border="1"> <thead> <tr> <th>Survey No.</th> <th>Village</th> <th>Mandal</th> <th>District</th> </tr> </thead> <tbody> <tr> <td>217,218,220,221,222,223,224, 225, 226, 227, 228, 229, 230</td> <td>Kurakalva Village</td> <td>Renigunta Mandal</td> <td>Chittoor District</td> </tr> <tr> <td>419,420,467,468,469,470, 474</td> <td>Vikruthamala Village</td> <td>Yerpedu Mandal</td> <td></td> </tr> </tbody> </table>	Survey No.	Village	Mandal	District	217,218,220,221,222,223,224, 225, 226, 227, 228, 229, 230	Kurakalva Village	Renigunta Mandal	Chittoor District	419,420,467,468,469,470, 474	Vikruthamala Village	Yerpedu Mandal	
Survey No.	Village	Mandal	District											
217,218,220,221,222,223,224, 225, 226, 227, 228, 229, 230	Kurakalva Village	Renigunta Mandal	Chittoor District											
419,420,467,468,469,470, 474	Vikruthamala Village	Yerpedu Mandal												
3.	Area of EMC	<p>113.27 acres</p> <ul style="list-style-type: none"> Processing area – 96.28 acres (85 %) Non-Processing area – 16.99 acres (15 %) 												
4.	Sector identified for the EMC	Mobile manufacturing units, components and accessories etc.												
5.	Timelines for formation of SPV	The application has been submitted by SPV and would be restructured (as per applicant's communication dated 10 th February, 2017) within 24 months from the date of approval or before the completion of the project (<i>whichever is earlier</i>) in compliance with the guidelines for the constitution of the SPV dated 30.01.2014 issued by MeitY												
6.	Project Timeline	24 months from the date of final approval												

TERMS AND CONDITIONS

3. This approval and Grant-in-aid is subject to compliance by SPV M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited to the EMC Scheme and Guidelines and other instructions, orders etc. issued by the Government of India from time to time, and the terms and conditions stipulated hereafter. Capitalized terms used in this letter shall have the meaning ascribed to such terms in **Annexure A** of this letter.

4. The Grant-in-aid has been approved on basis of the eligible activities, break-up of project cost and funding pattern approved by the competent authority under the Electronics Manufacturing Clusters Scheme which is provided in the table hereunder. M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited undertakes to comply with the eligible activities, break-up of project cost and funding pattern as provided herein.

#	Particulars	Unit (Sq. m.)	Rate	Processing/ Non-processing area)	Amount (In Rs.)
(A) BASIC DEVELOPMENT					
A.1	Site Grading and Development	78,026	250	Processing	1,95,06,540
A.2	Boundary Wall	19,529	4,492	Processing	8,77,28,845
A.3	Construction of Roads	8,872	7,180	Processing	6,37,04,725
A.4	Landscaping, Horticulture and Park Development	11.0		Processing	7,45,70,523
A.5	Drainage and Sewage Network	1,775	31,295	Processing	5,55,48,522
A.6	Water Supply Network		LS	Processing	3,00,00,000
A.7	Electrification Work (including poles, Lamps, hi-mast poles, street lights, laying of LT Lines)		LS	Processing	6,00,00,000
A.8	Water Supply Infra- Overhead Tank (Having Capacity of 16,800 Ltr.)		LS	Processing	27,25,043
A.9	Power Supply Infra- Electricity Power Substation (3.0 MVA drawn from 220/133 kV) Power Backup comprising switch room and DG set Shed (1.0 MVA -2 DG sets each)		LS	Processing	4,00,00,000
Sub-Total (A)					43,37,84,198
(B) MANUFACTURING SUPPORT FACILITY					
B.1	Tool Room & Moulding	2,974	78,466	Processing	23,33,57,561
B.2	Training Center & Lab (Ground floor)	1,032	28,052	Processing	2,89,49,160
B.3	Warehouses- (No.-4 of 25000 sq.ft each)	9,290	8,458	Processing	11,79,09,840
Sub- Total (B)					38,02,16,561

#	Particulars	Unit (Sq. m.)	Rate	Processing/ Non-processing area)	Amount (In Rs.)
(C) OTHER SUPPORT FACILITIES					
C.1	Seminar Hall (PEB)- (Ground floor with 1000 people capacity)	3,504	6,453	Processing	2,26,11,725
C.2	Visitors Facilitation Centre having 24 rooms and Employee Hostel with 96 Beds	4,400	20,222	Processing	8,89,77,882
C.3	Central Kitchen (Ground Floor + 2)	452	28,313	Non-Processing	1,27,97,685
C.4	Fire Station & Fire fighting Facilities - Building Cost (Ground floor)	188	12,240	Processing	2,30,11,975
C.5	Banking & ATM Facility - Building Cost (Ground Floor)	372	22,533	Processing	83,82,264
C.6	Landscaping, Horticulture and Park Development	11.0	LS	Non-Processing	39,88,588
Sub -Total (C)					15,97,70,119
(D) WELFARE FACILITIES					
D.1	First-aid-Centre (Ground Floor)	157	48,326	Non-Processing	75,87,219
D.2	Crèche (Ground Floor)	336	30,353	Non-Processing	1,01,98,658
D.3	Administrative Building & Office (Ground Floor)	787	22,533	Non-Processing	2,21,00,000
Sub-Total (D)					3,98,85,877
Sub-Total(A+B+C+D)					101,36,56,755
Admin Expenses (E)					3,04,09,703
Total Project Cost (A+B+C+D+E)					104,40,66,458

5. The details of the project cost and Grant-in-aid for the project approved by the competent authority under the Electronics Manufacturing Clusters Scheme are as provided in table hereunder. The SPV undertakes to comply with the project cost as provided herein.

(In Rs.)

#	Parameter	Area (In acre)	Project Cost	Grant – in – aid (from Govt)
1	Processing area	96.28	95,69,84,605	44,12,07,041
2	Non processing area	16.99	5,66,72,150	1,05,36,712
3	Administrative expenses	-	3,04,09,703	1,35,52,313
	Total	113.27	104,40,66,458	46,52,96,066

6. The details of funding for the project approved by the competent authority under the Electronics Manufacturing Clusters Scheme are as provided in the table hereunder. M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited undertakes to ensure the contribution from Cluster enterprises/ units to the tune of Rs. 34,61,22,359/-.

(In Rs.)

#	Funding Sources	Amount
1	Grant in-aid from Government of India	46,52,96,066
2	Promoter's / units contribution	34,61,22,359
3	Contribution from Govt. of Andhra Pradesh	23,26,48,033
	Total	104,40,66,458

7. **Implementation schedule:** The project components wise implementation schedule for the project approved by the competent authority under the Electronics Manufacturing Clusters Scheme is as provided hereunder. SPV M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited undertakes to implement the project within the approved timelines. In the event of considerable and persistent delay of the project, Government of India has the right to foreclose the project, appoint a new implementation agency for execution of the project and recover the entire Grant-in-aid released along with interest and penalties as stipulated in this approval letter.

(a) **Total duration of the project** – 24 months

(b) **Project Component-wise timeline:**

Particulars	Timeline
Basic Development	24 Months (1- 24 months)
Manufacturing Support Facility	11 Months (14-24 months)
Other Support Facility	11 Months (14-24 months)
Welfare facilities	16 Months (1-16 months)
Project Completion	24 Months

8. The SPV shall ensure that it is restructured in full compliance of terms and conditions laid out in the 'Guidelines for constitution of Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs)' dated 30th January 2014 and Electronics Manufacturing Cluster Scheme, the Guidelines thereof and any other instructions issued by MeitY from time to time. In the event of failing to comply with the conditions laid out in EMC Scheme and/ or Guidelines including the utilization of land or committing breach of the bond at any time, SPV shall be liable to refund to the President of India the entire amount of the Grant-in-aid with interest @ Prime Lending Rate (PLR) per annum prevailing at that time and as notified by Reserve Bank of India. SPV will also be liable to such other penalties as provided under the approval and any other law. MeitY may also take legal action for recovery of the dues as may be considered appropriate.

9. SPV shall execute a bond for proper utilization of grant wherein it shall undertake that it shall abide by the terms and conditions specified in the approval letter, the terms of the Scheme and Guidelines and any instruction issued by the Ministry of Electronics and Information Technology from time to time. SPV shall also be required to provide a Self-certified undertaking that they have not obtained or applied for grants for the same purpose or activity from any other Ministry or Department of the Government of India or State Government. In the event of failing to comply with the conditions laid out in EMC Scheme and/ or Guidelines including the utilization of land or committing breach of the bond at any time, SPV shall be liable to refund to the President of India the entire amount of the Grant-in-aid with interest @ Prime Lending Rate (PLR) per annum prevailing at that time and as notified by Reserve Bank of India and will be liable to such other penalties as provided under the approval and any other law. MeitY may also take legal action for recovery of the dues as may be considered appropriate.

10. SPV shall create an Escrow account with a Nationalized Bank and shall provide the details thereof to the Ministry of Electronics and Information Technology (MeitY) Government of India. The Government of India shall enter into a Tripartite Agreement (TPA) with SPV and the Bank where the escrow account of SPV is maintained for proper utilization of the central grant. The terms of the escrow account shall be as approved by the Government of India.

11. SPV shall ensure that minimum 80% of the land of the Electronic Manufacturing Cluster shall be allotted to processing area while remaining 20% of the land may be allotted for non-processing area. M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited shall ensure that a minimum of 75% units within the EMC should be from among the verticals covered under Modified Special Incentives Package Scheme

12. The disbursement of Grant-in-aid shall be made on *pari-passu* basis i.e. all proportionate payments to be released after the corresponding share to be mobilized by SPV and is deposited in the escrow account and other necessary conditions for release of such payments as prescribed have been complied. The same is to be applicable on all the installments with effect from the first installment to be released to the applicant.

13. The applicant shall also undertake to abide by all recommended conditions regarding allotment of land as per EMC scheme, Guidelines and terms & conditions of approval. Failure to abide by any of the above will make liable for penalties as envisaged under the Policy/ Guidelines and any other law. Necessary undertaking in this regard shall be provided by the applicant.

14. In the event of any shortfall in project funds, or non-collection of the contributions from the constituent units in successful completion of the project, the same will have to be mobilized and brought in by SPV.

15. The first installment of Grant-in-aid (i.e. 20% of the Grant-in-aid) will be released after compliance of other terms & conditions as mentioned in this approval letter and fulfilling of the below mentioned criteria's:

- a) Submission and execution of the requisite administrative legal documents viz; Bond, Memorandum of Agreement, Tripartite ESCROW Agreement (TPA) etc.
- b) After deposition of the equivalent proportionate contribution into the ESROW account.
- c) The land earmarked for the operations of the SPV should be in possession of the SPV.

16. The second Installment of Grant-in-aid (i.e. 30% of the Grant-in-aid) to be released on compliance of the following conditions:

- a) The SPV should be constituted in compliance with the requirements of "Guidelines for constitution of Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs) dated 30th January 2014."
- b) There should be at least three representative of the concerned Government on the Board of Directors in the SPV.
- c) After utilization of 80% of first installment and proportionate contribution from constituent units/ State Government/Chief Promoter.
- d) On recommendations of the Project Review Committee (PRC) .

17. Third Installment of Grant-in-aid (i.e. 30% of grant-in-aid) to be released on compliance of the following condition:

- a) At least two constituent units should have started setting up of manufacturing facilities within EMC
- b) Submission of all pending approvals viz. layout approvals, all environmental related approvals fire-fighting plan, clearance from Chief controller of Explosives etc. from their concerned authorities.
- c) After utilization of 80% of second installment and proportionate contribution from constituent units/ State Government/Chief Promoter.
- d) On recommendations of the Project Review Committee (PRC)

18. Fourth installment of Grant-in-aid (i.e. 20% of Grant-in-aid) will be released on compliance of the following conditions:

- a) Allotment of at least 80% of the saleable land to constituent units.
- b) Construction and setting up of manufacturing facility should have been started by at least 50% of the land allottees.
- c) After utilization of 100 % of earlier installments and proportionate contribution from constituent units/ State Government/Chief Promoter
- d) On successful completion of the project as decided
- e) On recommendations of the Project Review Committee (PRC)



19. The Government of India's disbursement will be effected to the escrow account only when proportionate contribution from SPV is deposited in the escrow account. All the payment to M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited will be released subject to and in accordance to clause 6.13 of the EMC Guidelines. The deposits in the escrow account shall be utilized only for authorized expenditure for the approved project. The bank guarantee mentioned in clause 6.13 of the EMC Guidelines shall be in a form acceptable to MeitY.
21. SPV shall provide status on quarterly basis to Project Monitoring Committee (PMC)/ MeitY on physical/ financial progress and the units being set up/ proposed to be set up in the EMC and ensure that at least 75% of the units should be engaged in Electronics System Design and Manufacturing (ESDM) as per M-SIPS Policy.
22. SPV shall be responsible for timely execution of the project and proper utilization of the funds.
23. The Grant-in-aid sanctioned by the Government of India would be utilized only for the project components mentioned in this letter.
24. Any escalation in the approved project cost or cost of the individual project component(s) shall be solely borne by the SPV. SPV shall arrange additional funds, if any required, to meet time and cost overruns. The Central grant for the purposes shall be limited to amount approved for Grant-in-aid as per this approval letter.
25. In the event of reduction of cost in a project component, the Central grant shall automatically get reduced on pro-rata basis for the said project component.
26. It shall be the responsibility of SPV to obtain necessary approvals and clearances as applicable before implementation.
27. SPV shall submit the "Utilization Certificate" on the basis of audit done by Chartered Accountant and after the acceptance of the same by its Board of Directors.
28. SPV shall maintain subsidiary accounts of the GOI grant and furnish to the Accounts Officer a set of audited statement of accounts. These audited statements of accounts should be furnished after utilization of Grant-in-aid or whenever called for.
29. SPV shall undertake all procurement of goods, equipment and services or any other item through a transparent and competitive procurement process. Appropriate performance guarantees should be built in the agreement(s) to ensure timely and good quality delivery of goods and services procured.
30. In case MeitY, Government of India is of the opinion that the implementation of the project or operation of the SPV is not satisfactory or in case of disputes amongst the Board members of the SPV, the Government of India would have the powers to effect a change in the management of the SPV or issue such directions as may be necessary. The Articles of Association of the SPV shall be suitably formulated and if required modified to enable the Government of India to enforce, if required the above conditions stipulated while sanctioning the Grant-in-aid.
31. Any other special terms and conditions or procedures for transaction of business, as Government may desire to be followed by the SPV, shall be incorporated in the Articles of Association of the SPV before release of Grant-in-aid.



32. The SPV shall appoint a Managing Director or Chief Executive Officer with approval of its Board of Directors. However, the appointment shall need ratification by the Ministry of Electronics and Information Technology thereafter. SPV or the Managing Director of the SPV, as the case be, would be the Drawing and Disbursing Officer for the amounts released under this approval letter.
33. SPV shall submit performance-cum-achievement report before applying for the next installment as grant (within 6 months from end of every Financial Year).
34. Accounts of SPV shall be open to inspection by the Ministry of Electronics and Information Technology and audit, both by the Comptroller and Auditor General of India under the provision of CAG (DPC) Act 1971 and internal audit by the Principal Accounts Office of the Ministry of Electronics and Information Technology, whenever SPV is called upon to do so.
35. SPV shall complete process for transfer of the roads and Right of Way as per proposal to Govt. of India for the Project.
36. The assets acquired wholly or substantially out of Government of India's Grant-in-aid shall not, without the prior sanction of the Government of India, be disposed of, encumbered or utilized for the purpose other than for which the Grant-in-aid has been released.
37. SPV shall provide a certificate of actual utilization of the grants received for the purpose for which it was sanctioned in latest format prescribed in GFR or notified by Ministry of Finance on time to time as and when required by the Government of India. The Utilization Certificate should be submitted within six months of the closure of the financial year by the SPV. Receipt of such certificate shall be scrutinized by MeitY. Where such certificate is not received from the SPV within the prescribed time, the Ministry or Department will be at liberty to blacklist such Chief Promoter and/ or the SPV from any future grant, subsidy or other type of financial support from the Government.
38. SPV shall maintain a register of permanent and semi-permanent assets acquired wholly or mainly out of the funds of Grant-in-aid on the basis of Form GFR -19.
39. SPV shall furnish a return of such assets acquired during a financial year in the Form-GFR-19 or as prescribed by Ministry of Finance on time to time basis.
40. The SPV shall fix user charges for various facilities and services provided by under the Project in order to ensure that it fully recovers the O&M cost and make the Project sustainable.
41. In case of winding up, dissolution, etc. of the SPV, at any point in time, all assets and any unutilized grant shall automatically vest with the Government of India.
42. SPV shall report on the physical progress as well as the expenditure incurred in the Project to the Nodal Officer of the EMC Scheme every quarter.
43. MeitY shall display on its website the details of the Project approved and the progress of its implementation.
44. Out of the Grant-in-aid, the administrative expenses (incurred during the execution of the project) shall be limited to that approved as per this approval letter. Administrative expenses beyond this amount shall be met by SPV from its own resources.



45. In the event of failing to comply with the conditions laid out in EMC Scheme and/ or Guidelines and/ or this approval letter (including the utilization of land) at any time, SPV shall be liable to refund to the President of India the entire amount of the Grant-in-aid with interest @ Prime Lending Rate (PLR) per annum of RBI thereon and will be liable to such other penalties as provided under the approval and any other law. MeitY shall also be entitled to take legal action for recovery of the dues as may be considered appropriate.

46. SPV shall submit all relevant documents within the timelines as specified in the EMC Scheme and Guidelines, demonstrating the fulfillment of all terms and conditions precedent at each stage.

47. The contents of this approval letter shall prevail in case of any conflict with any previous communication from MeitY/ GOI in this regard.

48. The terms and conditions of this approval letter are in addition to the standard terms and conditions mentioned in Annexure – 8 of the EMC Guidelines. In case of any conflict between the terms and conditions mentioned in this approval letter and the terms and conditions mentioned in the EMC Scheme or EMC Guidelines or any other terms and conditions imposed on the SPV regarding the Project, Government of India shall have the sole authority and right to decide which terms and conditions shall prevail and the decision of the Government of India shall be final and binding on the SPV.

49. In case of any dispute, Secretary, Ministry of Electronics and Information Technology, Government of India, shall be the sole "Arbitrator" and his decision shall be final and binding for all concerned.

Yours faithfully,



(Sanjay Koul)
Principal Technical Officer
Tel: 011-24301781

Copy to:

1. PS to Hon'ble Minister(E&IT) for kind information of Hon'ble Minister (E&IT),Govt. of India
2. PS to Hon'ble MOS(E&IT) for kind information of Hon'ble MOS(E&IT), Govt. of India
3. Secretary, MeitY
4. AS&FA, MeitY
5. Secretary, Department of IT and Electronics , Government of Andhra Pradesh



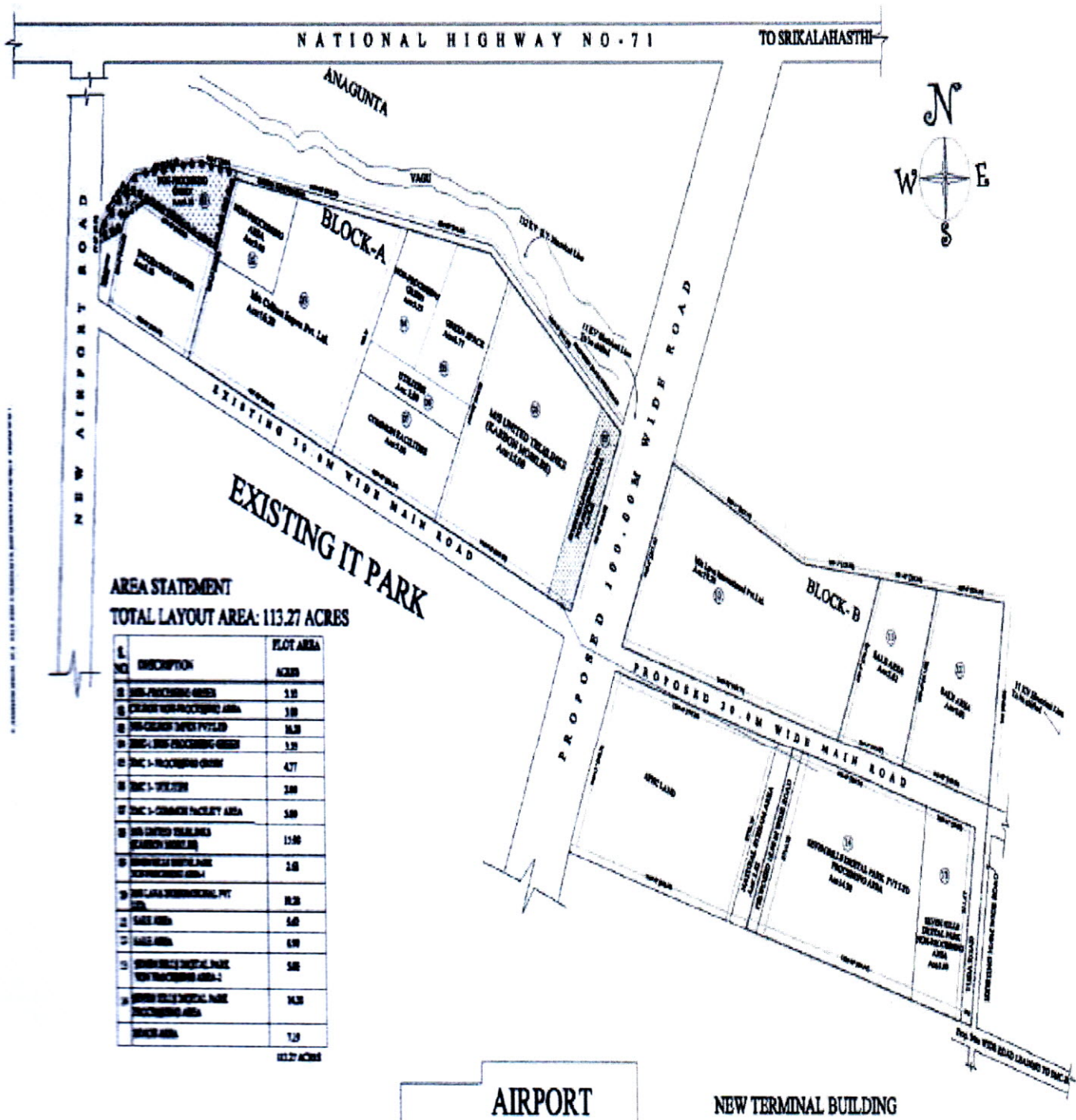
(Sanjay Koul)
Principal Technical Officer
Tel: 011-24301781

Definitions:

Capitalized terms used in the approval letter no. 36(9)/2017-IPHW (Vol.II) dated 7th December, 2017 issued to M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited shall have the meaning ascribed to such terms in the EMC Scheme and EMC Guidelines and where such terms are not defined therein, the terms shall have the meaning, unless the context otherwise requires, as provided below:

1. **SPV** : M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited
2. **Grant-in-aid**: Financial assistance provided by MeitY towards implementation of the project (refer para 4.1 of the EMC Scheme dated 22nd October, 2012).
3. **Project**: Project for setting up of Greenfield EMC at Renigunta and Yerpedu Mandal, Chittoor District, Near Airport, Tirupati, Andhra Pradesh submitted by M/s Sri Venkateswara Mobile & Electronics Manufacturing Hub Private Limited
4. **MeitY**: Ministry of Electronics and Information Technology, Government of India.
5. **PLR**: Prime Lending Rate as issued by RBI prevailing at the time occurrence of the event.
6. **GOI**: Ministry of Electronics and Information Technology acting for and on behalf of the President of India
7. **Form GFR-19**: General Financial Rules (GFR) issued by Ministry of Finance, Government of India from time to time.
8. **EMC Scheme**: Electronic Manufacturing Scheme Notification No. 252 dated 22nd October, 2012 in Part-I, Section 1 of the Gazette of India (Extraordinary) [F.No. 8(50)/2011-IPHW]
9. **EMC Guidelines**: Guidelines for Electronics Manufacturing Clusters (EMC) Scheme to provide world class infrastructure for attracting investments in the Electronics Systems Design and Manufacturing (ESDM) Sector dated 15th April, 2013 [F.No. 8(50)/2011-IPHW].
10. **SPV Guidelines**: Notification of Guidelines for constitution of Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs) dated 30th January, 2014 [F.No. 8(131)/2012-IPHW].
11. **Accounts Officer**: Accounts Officer appointed by Ministry of Electronics and Information Technology
12. **Utilization certificate**: Utilization Certificate stipulated as per format prescribed in GFR/ notified by Ministry of Finance on time to time.

Layout of the Greenfield Electronics Manufacturing Cluster at Renigunta and Yerpedu Mandal, Chittoor District, Near Airport, Tirupati, Andhra Pradesh



AREA STATEMENT
TOTAL LAYOUT AREA: 113.27 ACRES

S. NO.	DESCRIPTION	PLOT AREA ACRES
01	AREA FOR FENCING GREEN	1.10
02	CHAKRA SAREE PRIVATE AREA	1.50
03	M/S. CHAKRA SAREE PRIVATE	16.20
04	M/S. CHAKRA SAREE PRIVATE	1.50
05	M/S. CHAKRA SAREE PRIVATE	4.77
06	M/S. CHAKRA SAREE PRIVATE	2.80
07	M/S. CHAKRA SAREE PRIVATE	5.80
08	M/S. LIMITED TEXTILES (SARANYA SAREES)	15.00
09	M/S. CHAKRA SAREE PRIVATE	2.80
10	M/S. CHAKRA SAREE PRIVATE	16.20
11	SALE AREA	5.60
12	SALE AREA	6.50
13	M/S. CHAKRA SAREE PRIVATE	5.80
14	M/S. CHAKRA SAREE PRIVATE	16.20
15	SALE AREA	7.10
		113.27 ACRES

Documents related to Survey No. of the Greenfield EMC at Renigunta and Yerpedu Mandal, Chittoor District, near Airport, Tirupati, Andhra Pradesh:



**SRI VENKATESWARA MOBILE & ELECTRONICS
MANUFACTURING HUB PRIVATE LIMITED**

REF: SVM&EMH/VP/MEITY/024

DATE: 04-10-2017

To
Sri. Sanjay Koul,
Nodal Officer,
Ministry of Electronics and Information Technology,
Electronics Nikethan,
CGO Complex,
Lodhi Road,
New Delhi.

Sir,
Sub: Details of land Survey numbers in EMC-1 i.e., Sri Venkateshwara Mobiles and Electronics Manufacturing Hub.

With reference to the above subject we here by inform you that the following survey numbers along with village details are furnished as here under:

1. Sy. No: 217, 218, 220, 221, 222, 223, 224, 225, 226, 227, 228, 229, 230 of Kurakaluva village in Renigunta Mandalam, Chittoor District.

These are the survey numbers are allotted for

- m/s Celkon Impex Private Limited,
 - m/s Sojo Telecommunications South India Private Limited (LAVA),
 - m/s United Tele links (Karbon) and
 - Partially 7 Hills Digital Park Private Limited.
- Named as Block - A**

2. Sy. No: 419, 420, 467, 468, 469, 470 and 474 of Vikrutamala village in Yerpedu mandalam, Chittoor District.

These are the survey numbers allotted for common facility area, Roads, 7 Hills digital park and the balance land to be sold to other 3 new entrepreneurs who are yet to join the EMC-1.

Named as Block - B

This is for your favor of information and action.

With best regards,

For SVM&EMH Pvt. Ltd.

**NARASIMHAN.L.V
VICE-PRESIDENT**

